



DOCKET NO.: 01-C-055  
CLIENT NO.: STMI01-01055  
Customer No.: 30425

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: : Harry Michael Siegel et al.  
Application No. : 10/062,595  
Filed : January 31, 2002  
For : SYSTEM AND METHOD FOR ALIGNING AN INTEGRATED  
CIRCUIT DIE ON AN INTEGRATED CIRCUIT SUBSTRATE  
Group No. : 3725  
Examiner : David B. Jones

**MAIL STOP ISSUE FEE**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT UNDER 37 C.F.R. § 1.312**

Pursuant to 37 C.F.R. § 1.312, please amend the above-identified application as follows: